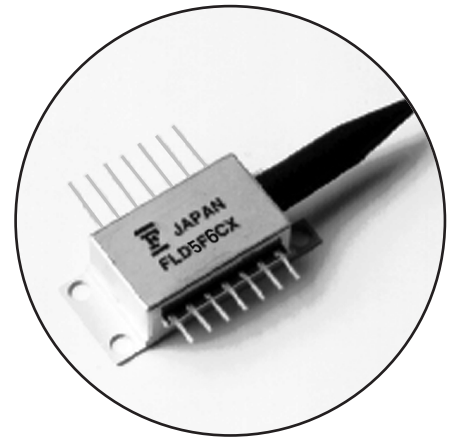


FEATURES

- Direct Modulated MQW DFB Laser
- Built-in TEC, Thermistor and Monitor PD
- 14-Pin Butterfly Type Module
- 10mW Output Power
- Low Residual Chirp
- Optimized for 2.5 Gb/s Modulation Rates
- Selected wavelengths according to ITU-T grid available

APPLICATIONS

This MQW laser is intended for the application of 2.5 Gb/s long haul Dense Wavelength Division Multiplexing (DWDM). Transmission spans of 100 km are possible without amplification.



DESCRIPTION

The Multiple Quantum Well (MQW) Laser is a high power laser capable of 2.5 Gb/s transmission. It is packaged in a “butterfly” type module. The module employs a high efficiency optical coupling system, coupling the laser output through a built-in optical isolator into a single mode fiber pigtail. The modules also include a monitor photodiode, a thermoelectric cooler (TEC) and thermistor. This device is designed for use in DWDM direct modulation transmission systems. Selected wavelengths specified to the ITU-T grid are available.

ABSOLUTE MAXIMUM RATINGS (T_C=25°C)

Parameter	Symbol	Condition	Ratings	Unit
Storage Temperature	T _{stg}	-	-40 to +70	°C
Operating Case Temperature	T _{op}	-	-20 to +65	°C
Optical Output Power	P _f	CW	12.0	mW
Forward Current	I _F	CW	150	mA
Reverse Voltage	V _R	-	2	V
Photodiode Reverse Voltage	V _{DR}	-	20	V
Photodiode Forward Current	I _{DF}	-	10	mA
TEC Voltage	V _C	-	2.5	V
TEC Current	I _C	-	1.4	A
Lead Soldering Time	T _{sold}	<260°C	10	sec
Environmental Operating Humidity	X _{op}	T _{op} <30°C	95	%
Environmental Storage Humidity	X _{st}	T _{st} <30°C	95	%

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1,550nm MQW-DFB DWDM Direct Modulation Laser

OPTICAL AND ELECTRICAL CHARACTERISTICS (T_L=T_{set}, T_C=25°C, BOL, unless otherwise specified)

Parameter	Symbol	Conditions	Limits			Unit
			Min.	Typ.	Max.	
Laser Set Temperature	T _{set}	-	20	-	35	°C
Threshold Current	I _{th}	CW	3	-	40	mA
Forward Voltage	V _{FDC}	CW, I _F =30 mA, pin 12-13	-	1.6	1.75	V
Series Resistance	R _S	CW, pin 12-13	22	25	28	Ω
Reverse Voltage	V _R	CW, at I _R <1500μA	2	-	-	V
Optical Output Power	P _f	CW	10.0	-	-	mW
Slope Efficiency	η	CW, P _f =10mW	0.14	-	-	mW/mA
Threshold Power	P _{th}	I _F =I _{th} , CW	-	-	150	μW
Tracking Error (Note 1)	TE	P _f =10mW, T _C =-20 to 65°C	-0.5	-	+0.5	dB
Monitor Current	I _m	CW, P _f =10mW, V _{DR} =5V	0.10	-	1.0	mA
Photodiode Dark Current	I _D	V _{DR} =5V	-	2	100	nA
Photodiode Capacitance	C _t	V _{DR} =5V, f=1 MHz	-	-	10	pF
Photodiode Cutoff Frequency	f _{cm}	V _{DR} =5V, 50Ω load	100	-	-	MHz
Peak Wavelength	λ _p	Note (2)	Note (4)			nm
Wavelength Drift	-	after 20 years	-	-	0.2	nm
Wavelength Stability with Case Temperature	-	-	-	-	+/-2	pm/°C
Side Mode Suppression	S _r	Note (2)	33	35	-	dB
Spectral Width (-20dB)	-	Note (2)	-	-	0.5	nm
Rise Time (10%-90%)	t _r	Note (2)	-	0.1	0.125	nsec
Fall Time (10%-90%)	t _f	Note (2)	-	0.1	0.125	nsec
Cutoff Frequency	f _c	P _f =10mW, -3 dB	4.0	-	-	GHz
In-Band Ripple (Window)	S ₂₁	f=50 MHz~3 GHz	-	-	+/-1.5	dB
RF Return Loss	S ₁₁	f=50 MHz~2 GHz	8	-	-	dB
		f=2 GHz~3 GHz	6	-	-	dB
		f=3 GHz~5 GHz	3	-	-	dB
Optical Isolation	I _S	T _C =-20 to 65°C	25	35	-	dB
Relative Intensity Noise	RIN	f=2.5 GHz P _f =10 mW, ORL=24 dB	-	-	-140	dB/Hz
Kinks (up to 2.4 mW)	Kns	-	None			
Pulsation	-	-	None			
BER Performance	ER	Note (3)	No Floor			
Power Penalty	PP	Note (3)	-	-	1.5	dB

Note 1. TE=10*log(pf(Tcase)/Pf(Tc=25°C))dB, APC

Note 2. 2.5 Gb/s NRZ, pseudo-random, P_b=0.2mW, P_{peak}=2.0mW

Note 3. Bit rate=2.48832 Gb/s, PRBS=2²³-1, Dispersion=1,800 ps/nm (116km), P_{peak}=10mW,

P_{bias}=1.0mW (Extinction ratio=10dB), B.E.R.=1x10⁻¹⁰

Decision point: Center of Back-to-Back at 10⁹

Receiver: Fujitsu Standard Receiver

Note 4. The selected wavelength is available which is listed in Fig. 8

TEC AND THERMISTOR CHARACTERISTICS ($T_L=T_{set}$, $T_C=25^\circ\text{C}$, BOL, unless otherwise specified)

Parameter	Symbol	Test Conditions	Limit			Unit
			Min.	Typ.	Max.	
TEC Current	I_C	$T_L=T_{set}$, $P_f=10\text{mW}$, $T_c=65^\circ\text{C}$	-	-	1.0	A
TEC Voltage	V_C	$T_L=T_{set}$, $P_f=10\text{mW}$, $T_c=65^\circ\text{C}$	-	-	2.4	V
Cooler Power	P_{TEC}	$T_L=T_{set}$, $P_f=10\text{mW}$, $T_c=65^\circ\text{C}$	-	-	2.4	W
TEC Resistance	R_{TEC}	$T_L=T_{set}$, $P_f=10\text{mW}$, $T_c=65^\circ\text{C}$	2.0	2.4	3.2	Ω
Thermistor Resistance	R_{tr}	$T_L=15$ to 35°C	7.7	-	12.6	k Ω
Thermistor B Constant	B	-	3,270	3,450	3,630	K

Fig. 1 Forward Current vs Output Power

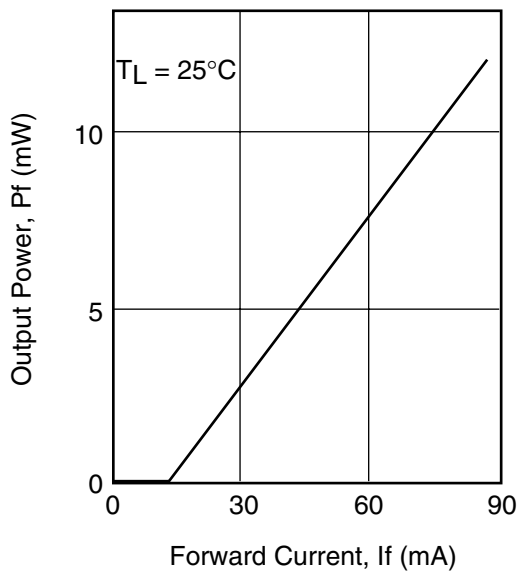
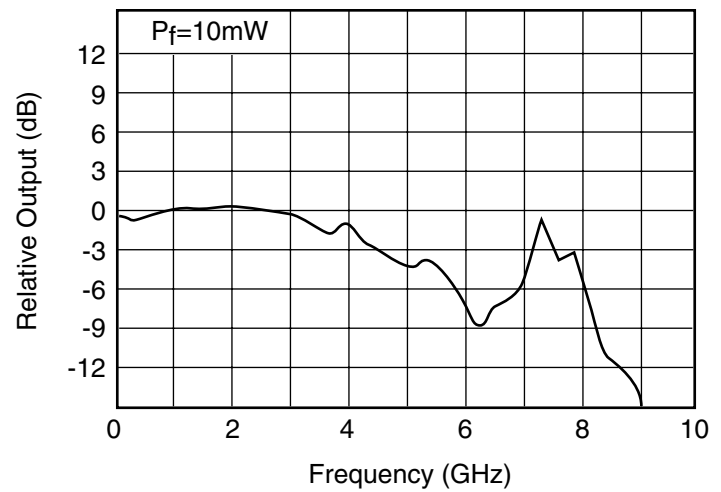


Fig. 2 Frequency Response



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Fig. 3 RF Return Loss

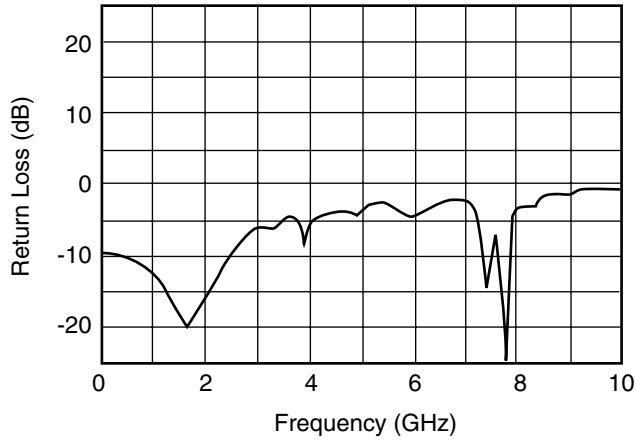


Fig. 4 Cooler Voltage -Current

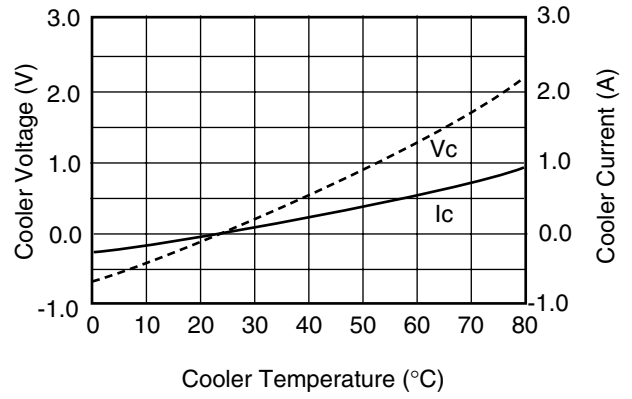


Fig. 5 Spectrum

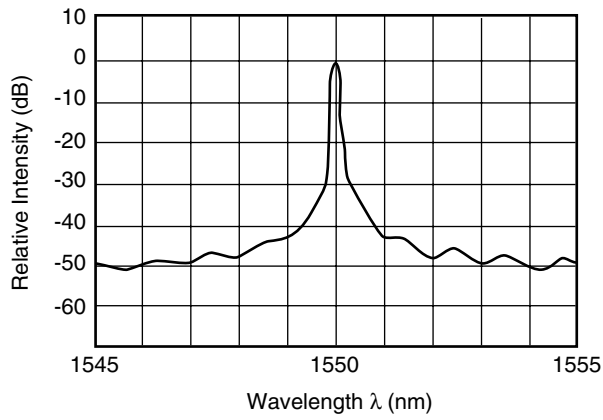


Fig. 6 Temperature Dependence of Wavelength

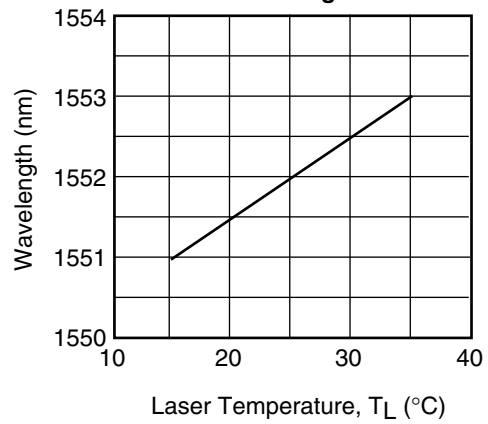


Fig. 7 Transmission Characteristics

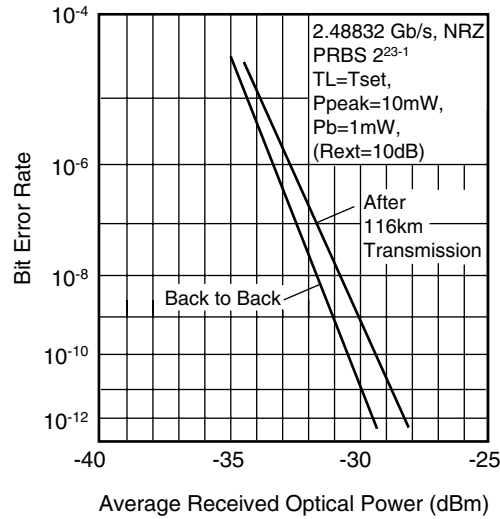


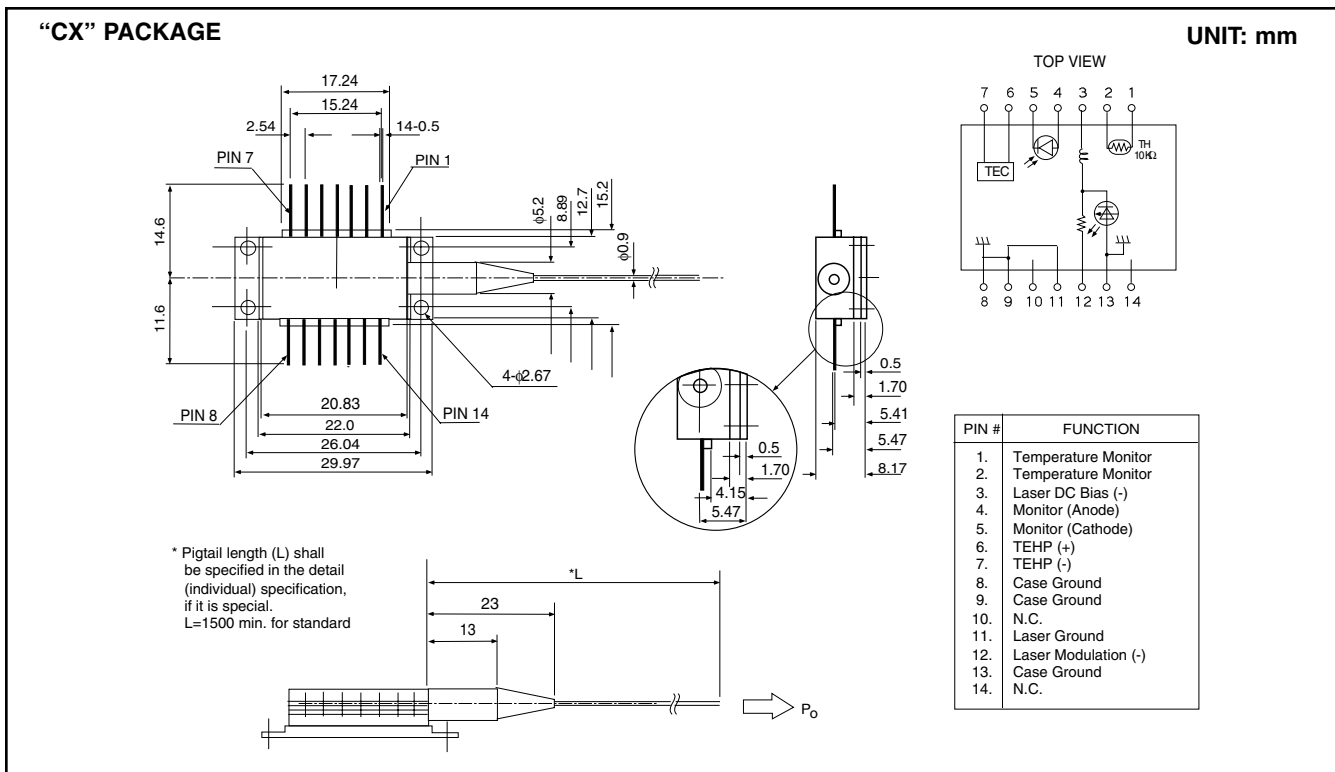
Fig. 8 Wavelength Table

Part Number	Wavelength (nm) (TL=Tset) (in vacuum)	Tolerance (nm)
FLD5F6CX-J62	1527.99	±0.1
-J61	1528.77	±0.1
-J60	1529.55	±0.1
-J59	1530.33	±0.1
-J58	1531.12	±0.1
-J57	1531.90	±0.1
-J56	1532.68	±0.1
-J55	1533.47	±0.1
-J54	1534.25	±0.1
-J53	1535.04	±0.1
-J52	1535.82	±0.1
-J51	1536.61	±0.1
-J50	1537.40	±0.1
-J49	1538.19	±0.1
-J48	1538.98	±0.1
-J47	1539.77	±0.1
-J46	1540.56	±0.1
-J45	1541.35	±0.1
-J44	1542.14	±0.1
-J43	1542.94	±0.1
-J42	1543.73	±0.1

-J41	1544.53	±0.1
-J40	1545.32	±0.1
-J39	1546.12	±0.1
-J38	1546.92	±0.1
-J37	1547.72	±0.1
-J36	1548.51	±0.1
-J35	1549.32	±0.1
-J34	1550.12	±0.1
-J33	1550.92	±0.1
-J32	1551.72	±0.1
-J31	1552.52	±0.1
-J30	1553.33	±0.1
-J29	1554.13	±0.1
-J28	1554.94	±0.1
-J27	1555.75	±0.1
-J26	1556.55	±0.1
-J25	1557.36	±0.1
-J24	1558.17	±0.1
-J23	1558.98	±0.1
-J22	1559.79	±0.1
-J21	1560.61	±0.1
-J20	1561.42	±0.1
-J19	1562.23	±0.1
-J18	1563.05	±0.1

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